5 V, 3.3 V and 2.5 V quad UART, 5 Mbit/s (max.) with 64-byte FIFOs

Rev. 02 — 13 June 2005

Product data sheet

# 1. General description

The SC16C754B is a quad Universal Asynchronous Receiver/Transmitter (UART) with 64-byte FIFOs, automatic hardware/software flow control, and data rates up to 5 Mbit/s (3.3 V and 5 V). The SC16C754B offers enhanced features. It has a transmission control register (TCR) that stores receiver FIFO threshold levels to start/stop transmission during hardware and software flow control. With the FIFO RDY register, the software gets the status of TXRDY/RXRDY for all four ports in one access. On-chip status registers provide the user with error indications, operational status, and modem interface control. System interrupts may be tailored to meet user requirements. An internal loop-back capability allows on-board diagnostics.

The UART transmits data, sent to it over the peripheral 8-bit bus, on the TX signal and receives characters on the RX signal. Characters can be programmed to be 5, 6, 7, or 8 bits. The UART has a 64-byte receive FIFO and transmit FIFO and can be programmed to interrupt at different trigger levels. The UART generates its own desired baud rate based upon a programmable divisor and its input clock. It can transmit even, odd, or no parity and 1, 1.5, or 2 stop bits. The receiver can detect break, idle, or framing errors, FIFO overflow, and parity errors. The transmitter can detect FIFO underflow. The UART also contains a software interface for modem control operations, and has software flow control and hardware flow control capabilities.

The SC16C754B is available in plastic LQFP64, LQFP80 and PLCC68 packages.

# 2. Features

- 4 channel UART
- 5 V, 3.3 V and 2.5 V operation
- Pin compatible with SC16C654IA68, TL16C754, and SC16C554IA68 with additional enhancements, and software compatible with TL16C754
- Up to 5 Mbit/s data rate (at 3.3 V and 5 V; at 2.5 V maximum data rate is 3 Mbit/s)
- 5 V tolerant inputs
- 64-byte transmit FIFO
- 64-byte receive FIFO with error flags
- Industrial temperature range (-40 °C to +85 °C)
- Programmable and selectable transmit and receive FIFO trigger levels for DMA and interrupt generation
- Software (Xon/Xoff)/hardware (RTS/CTS) flow control
  - Programmable Xon/Xoff characters
  - Programmable auto-RTS and auto-CTS

# PHILIPS

#### **Philips Semiconductors**

#### 5 V, 3.3 V and 2.5 V quad UART, 5 Mbit/s (max.) with 64-byte FIFOs

- Optional data flow resume by Xon any character
- DMA signalling capability for both received and transmitted data
- Supports 5 V, 3.3 V and 2.5 V operation
- Software selectable baud rate generator
- Prescaler provides additional divide-by-4 function
- Fast data bus access time
- Programmable Sleep mode
- Programmable serial interface characteristics
  - 5, 6, 7, or 8-bit characters
  - Even, odd, or no-parity bit generation and detection
  - 1, 1.5, or 2 stop bit generation
- False start bit detection
- Complete status reporting capabilities in both normal and Sleep mode
- Line break generation and detection
- Internal test and loop-back capabilities
- Fully prioritized interrupt system controls
- Modem control functions (CTS, RTS, DSR, DTR, RI, and CD)
- Sleep mode

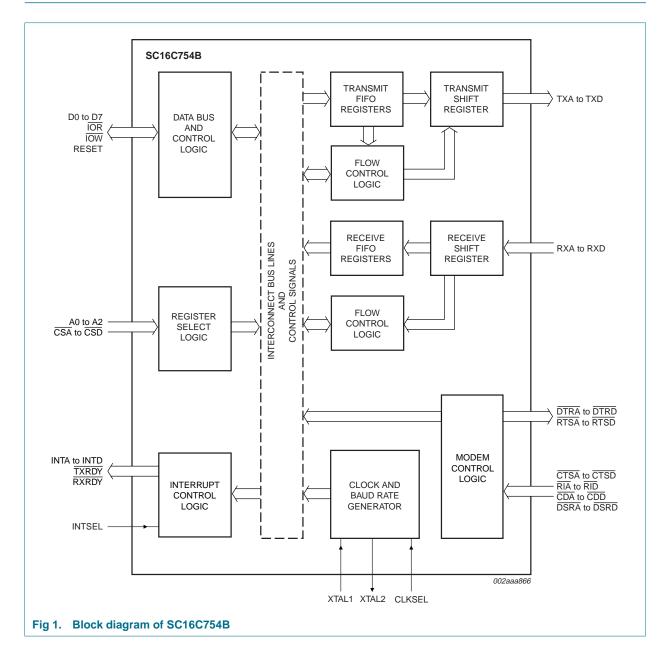
# 3. Ordering information

#### Table 1:Ordering information

Type number	Package	Package		
	Name	Description	Version	
SC16C754BIBM	LQFP64	plastic low profile quad flat package; 64 leads; body $7 \times 7 \times 1.4$ mm	SOT414-1	
SC16C754BIB80	LQFP80	plastic low profile quad flat package; 80 leads; body $12 \times 12 \times 1.4 \text{ mm}$	SOT315-1	
SC16C754BIA68	PLCC68	plastic leaded chip carrier; 68 leads	SOT188-2	



# 4. Block diagram

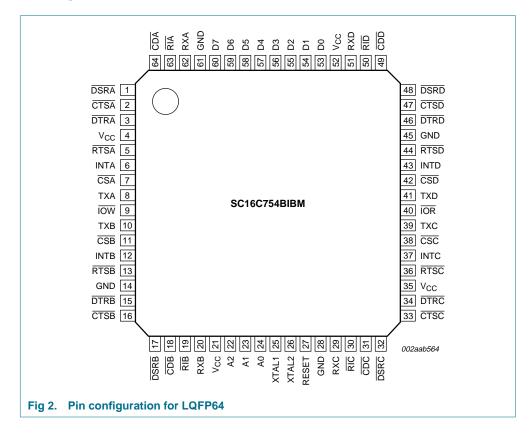


9397 750 14668 Product data sheet



# 5. Pinning information

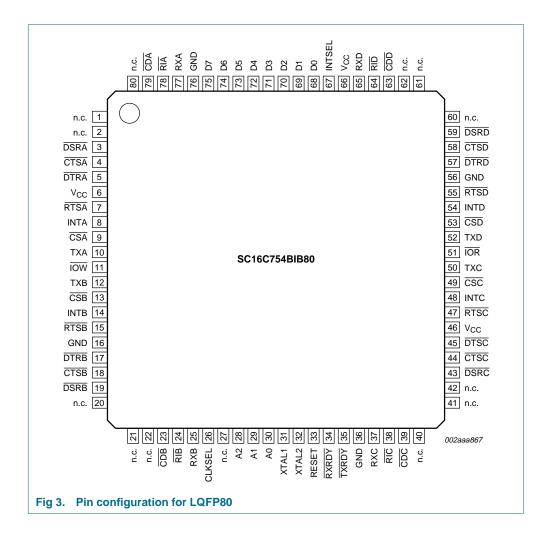
### 5.1 Pinning



9397 750 14668 Product data sheet

#### **Philips Semiconductors**

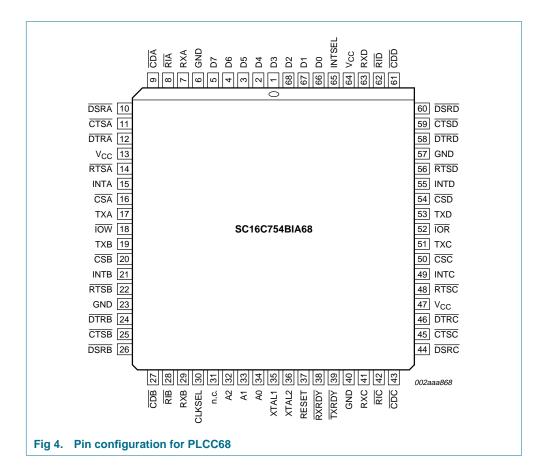
5 V, 3.3 V and 2.5 V quad UART, 5 Mbit/s (max.) with 64-byte FIFOs



9397 750 14668 Product data sheet

#### **Philips Semiconductors**

5 V, 3.3 V and 2.5 V quad UART, 5 Mbit/s (max.) with 64-byte FIFOs



#### 5.2 Pin description

Symbol Pin			Туре	Description	
	LQFP64	LQFP80	PLCC68		
A0	24	30	34	I.	Address 0 select bit. Internal registers address selection.
A1	23	29	33	I	Address 1 select bit. Internal registers address selection.
A2	22	28	32	I	Address 2 select bit. Internal registers address selection.
CDA	64	79	9	<ul> <li>Carrier Detect (active LOW). These inputs are associated with</li> <li>individual UART channels A through D. A logic LOW on these pi</li> <li>indicates that a carrier has been detected by the modem for that channel. The state of these inputs is reflected in the modem state</li> </ul>	
CDB	18	23	27		
CDC	31	39	43		
CDD	49	63	61	_	register (MSR).
CLKSEL	-	26	30	1	<b>Clock Select.</b> CLKSEL selects the divide-by-1 or divide-by-4 prescalable clock. During the reset, a logic 1 (V <sub>CC</sub> ) on CLKSEL selects the divide-by-1 prescaler. A logic 0 (GND) on CLKSEL selects the divide-by-4 prescaler. The value of CLKSEL is latched into MCR[7] at the trailing edge of RESET. A logic 1 (V <sub>CC</sub> ) on CLKSEL will latch a 0 into MCR[7]. A logic 0 (GND) on CLKSEL will latch a 1 into MCR[7]. MCR[7] can be changed after RESET to alter the prescaler value. This pin is associated with LQFP80 and PLCC68 packages only. This pin is connected to V <sub>CC</sub> internally on LQFP64 package.

Product data sheet

Rev. 02 — 13 June 2005

# **Philips Semiconductors**

# 5 V, 3.3 V and 2.5 V quad UART, 5 Mbit/s (max.) with 64-byte FIFOs

Table 2:	Pin descriptioncontinued					
Symbol	Pin			Туре	Description	
	LQFP64	LQFP80	PLCC68			
CSA	7	9	16	I	Chip Select (active LOW). These pins enable data transfers	
CSB	11	13	20	<ul> <li>between the user CPU and the SC16C754B for the channel(s)</li> <li>addressed. Individual UART sections (A, B, C, D) are addressed by providing a logic LOW on the respective CSA through CSD pins.</li> </ul>		
CSC	38	49	50			
CSD	42	53	54			
CTSA	2	4	11	I	Clear to Send (active LOW). These inputs are associated with	
CTSB	16	18	25		individual UART channels A through D. A logic 0 (LOW) on the CTS pins indicates the modem or data set is ready to accept transmit data	
CTSC	33	44	45		from the SC16C754B. Status can be tested by reading MSR[4].	
CTSD	47	58	59		These pins only affect the transmit and receive operations when Auto-CTS function is enabled via the Enhanced Feature Register EFR[7] for hardware flow control operation.	
D0 to D7	53, 54, 55, 56, 57, 58, 59, 60	68, 69, 70, 71, 72, 73, 74, 75	66, 67, 68, 1, 2, 3, 4, 5	I/O	<b>Data bus (bi-directional).</b> These pins are the 8-bit, 3-state data bus for transferring information to or from the controlling CPU. D0 is the least significant bit and the first data bit in a transmit or receive serial data stream.	
DSRA	1	3	10	I	Data Set Ready (active LOW). These inputs are associated with	
DSRB	17	19	26	_	individual UART channels A through D. A logic 0 (LOW) on these pins indicates the modem or data set is powered-on and is ready for data	
DSRC	32	43	44	_	exchange with the UART. The state of these inputs is reflected in the	
DSRD	48	59	60	_	modem status register (MSR).	
DTRA	3	5	12	O Data Terminal Ready (active LOW). These outputs are associa		
DTRB	15	17	24	with individual UART channels A through D. A logic 0 (LOW) on		
DTRC	34	45	46		pins indicates that the SC16C754B is powered-on and ready. The pins can be controlled via the modem control register. Writing a	
DTRD	46	57	58		logic 1 to MCR[0] will set the $\overline{\text{DTR}}$ output to logic 0 (LOW), enabling the modem. The output of these pins will be a logic 1 after writing a logic 0 to MCR[0], or after a reset.	
GND	14, 28, 45, 61	16, 36, 56, 76	6, 23, 40, 57	I	Signal and power ground.	
INTA	6	8	15	0	Interrupt A, B, C, and D (active HIGH). These pins provide	
INTB	12	14	21	_	individual channel interrupts INTA through INTD. INTA through INTD are enabled when MCR[3] is set to a logic 1, interrupt sources are	
INTC	37	18	49		enabled in the interrupt enable register (IER). Interrupt conditions	
INTD	43	54	55		include: receiver errors, available receiver buffer data, available transmit buffer space, or when a modem status flag is detected. INTA to INTD are in the high-impedance state after reset.	
INTSEL	-	67	65	I	Interrupt select (active HIGH with internal pull-down). INTSEL can be used in conjunction with MCR[3] to enable or disable the 3-state interrupts INTA to INTD or override MCR[3] and force continuous interrupts. Interrupt outputs are enabled continuously by making this pin a logic 1. Driving this pin LOW allows MCR[3] to control the 3-state interrupt output. In this mode, MCR[3] is set to a logic 1 to enable the 3-state outputs. This pin is associated with LQFP80 and PLCC68 packages only. This pin is connected to GND internally on the LQFP64 package.	
IOR	40	51	52	I	<b>Input/Output Read strobe (active LOW).</b> A HIGH-to-LOW transition on IOR will load the contents of an internal register defined by address bits A[2:0] onto the SC16C754B data bus (D[7:0]) for access by external CPU.	
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#### Table 2: Pin description ...continued

9397 750 14668

Product data sheet

# **Philips Semiconductors**

# SC16C754B

#### 5 V, 3.3 V and 2.5 V quad UART, 5 Mbit/s (max.) with 64-byte FIFOs

Table 2:	-	Pin descriptioncontinued			Provide the second s	
Symbol	Pin			Туре	Description	
	LQFP64					
ĪOW	9	11	18	I	<b>Input/Output Write strobe (active LOW).</b> A LOW-to-HIGH transition on $\overline{IOW}$ will transfer the contents of the data bus (D[7:0]) from the external CPU to an internal register that is defined by address bits A[2:0] and $\overline{CSA}$ and $\overline{CSD}$ .	
n.c.	-	1, 2, 20, 21, 22, 27, 40, 41, 42, 60, 61, 62, 80	31	-	not connected	
RESET	27	33	37	I	<b>Reset.</b> This pin will reset the internal registers and all the outputs. The UART transmitter output and the receiver input will be disabled during reset time. RESET is an active HIGH input.	
RIA	63	78	8	I	Ring Indicator (active LOW). These inputs are associated with	
RIB	19	24	28	_	individual UART channels, A through D. A logic 0 on these pins	
RIC	30	38	42	_	indicates the modem has received a ringing signal from the telephone line. A LOW-to-HIGH transition on these input pins generates a	
RID	50	64	62	-	modem status interrupt, if enabled. The state of these inputs is reflected in the modem status register (MSR).	
RTSA	5	7	14	0	Request to Send (active LOW). These outputs are associated with	
RTSB	13	15	22	individual UART channels, A through D. A logic 0 on the RTS p indicates the transmitter has data ready and waiting to send. W		
RTSC	36	47	48		a logic 1 in the modem control register MCR[1] will set this pin to a	
RTSD	44	55	56	-	logic 0, indicating data is available. After a reset these pins are set to a logic 1. These pins only affect the transmit and receive operations when Auto-RTS function is enabled via the Enhanced Feature Register (EFR[6]) for hardware flow control operation.	
RXA	62	77	7	I	Receive data input. These inputs are associated with individual	
RXB	20	25	29	_	serial channel data to the SC16C754B. During the local loop-back mode, these RX input pins are disabled and TX data is connected to	
RXC	29	37	41	_	the UART RX input internally.	
RXD	51	65	63	_		
RXRDY	-	34	38	0	<b>Receive Ready (active LOW).</b> RXRDY contains the wire-ORed status of all four receive channel FIFOs, RXRDY A to RXRDY D. It goes LOW when the trigger level has been reached or a time-out interrupt occurs. It goes HIGH when all RX FIFOs are empty and there is an error in RX FIFO. This pin is associated with LQFP80 and PLCC68 packages only.	
TXA	8	10	17	0	Transmit data. These outputs are associated with individual serial	
ТХВ	10	12	19	-	transmit channel data from the SC16C754B. During the local	
ТХС	39	50	51	-	loop-back mode, the TX output pin is disabled and TX data is internally connected to the UART RX input.	
TXD	41	52	53	-	,	
TXRDY	-	35	39	0	<b>Transmit Ready (active LOW).</b> TXRDY contains the wire-ORed status of all four transmit channel FIFOs, TXRDY A to TXRDY D. It goes LOW when there are a trigger level number of spaces available It goes HIGH when all four TX buffers are full. This pin is associated with LQFP80 and PLCC68 packages only.	

#### Table 2: Pin description ...continued

9397 750 14668

Product data sheet

#### **Philips Semiconductors**

5 V, 3.3 V and 2.5 V quad UART, 5 Mbit/s (max.) with 64-byte FIFOs

Symbol	Pin			Туре	Description
	LQFP64	LQFP80	PLCC68	1	
V <sub>CC</sub>	4, 21, 35, 52	6, 46, 66	13, 47, 64	I	Power supply input.
XTAL1	25	31	35	I	<b>Crystal or external clock input.</b> Functions as a crystal input or as an external clock input. A crystal can be connected between XTAL1 and XTAL2 to form an internal oscillator circuit (see Figure 14). Alternatively, an external clock can be connected to this pin to provide custom data rates.
XTAL2	26	32	36	0	<b>Output of the crystal oscillator or buffered clock.</b> (See also XTAL1.) XTAL2 is used as a crystal oscillator output or a buffered clock output.

#### Table 2: Pin description ...continued

# 6. Functional description

The SC16C754B UART is pin-compatible with the SC16C554 and SC16C654 UARTs. It provides more enhanced features. All additional features are provided through a special enhanced feature register.

The UART will perform serial-to-parallel conversion on data characters received from peripheral devices or modems, and parallel-to-parallel conversion on data characters transmitted by the processor. The complete status of each channel of the SC16C754B UART can be read at any time during functional operation by the processor.

The SC16C754B can be placed in an alternate mode (FIFO mode) relieving the processor of excessive software overhead by buffering received/transmitted characters. Both the receiver and transmitter FIFOs can store up to 64 bytes (including three additional bits of error status per byte for the receiver FIFO) and have selectable or programmable trigger levels. Primary outputs  $\overrightarrow{\text{RXRDY}}$  and  $\overrightarrow{\text{TXRDY}}$  allow signalling of DMA transfers.

The SC16C754B has selectable hardware flow control and software flow control. Hardware flow control significantly reduces software overhead and increases system efficiency by automatically controlling serial data flow using the  $\overline{\text{RTS}}$  output and  $\overline{\text{CTS}}$  input signals. Software flow control automatically controls data flow by using programmable Xon/Xoff characters.

The UART includes a programmable baud rate generator that can divide the timing reference clock input by a divisor between 1 and  $(2^{16} - 1)$ .

#### 6.1 Trigger levels

The SC16C754B provides independent selectable and programmable trigger levels for both receiver and transmitter DMA and interrupt generation. After reset, both transmitter and receiver FIFOs are disabled and so, in effect, the trigger level is the default value of one byte. The selectable trigger levels are available via the FCR. The programmable trigger levels are available via the TLR.

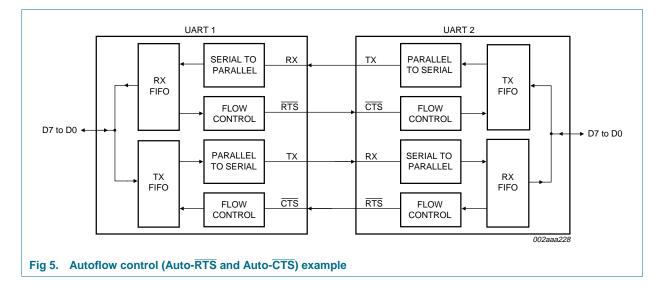
#### 6.2 Hardware flow control

Hardware flow control is comprised of Auto- $\overline{CTS}$  and Auto- $\overline{RTS}$ . Auto- $\overline{CTS}$  and Auto- $\overline{RTS}$  can be enabled/disabled independently by programming EFR[7:6].

With Auto-CTS, CTS must be active before the UART can transmit data.

Auto- $\overline{\text{RTS}}$  only activates the  $\overline{\text{RTS}}$  output when there is enough room in the FIFO to receive data and de-activates the  $\overline{\text{RTS}}$  output when the RX FIFO is sufficiently full. The halt and resume trigger levels in the TCR determine the levels at which  $\overline{\text{RTS}}$  is activated/deactivated.

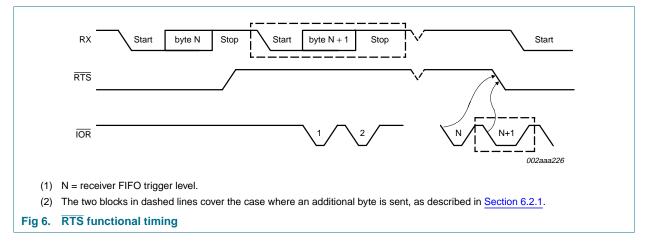
If both Auto-CTS and Auto-RTS are enabled, when RTS is connected to CTS, data transmission does not occur unless the receiver FIFO has empty space. Thus, overrun errors are eliminated during hardware flow control. If not enabled, overrun errors occur if the transmit data rate exceeds the receive FIFO servicing latency.



9397 750 14668 Product data sheet

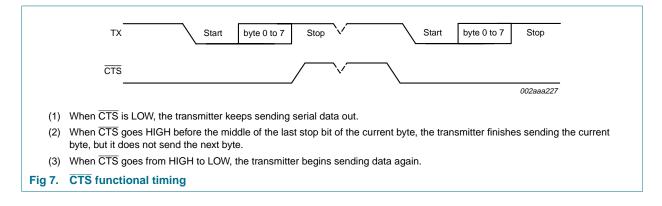
### 6.2.1 Auto-RTS

Auto-RTS data flow control originates in the receiver block (see Figure 1 "Block diagram of SC16C754B" on page 3). Figure 6 shows RTS functional timing. The receiver FIFO trigger levels used in Auto-RTS are stored in the TCR. RTS is active if the RX FIFO level is below the halt trigger level in TCR[3:0]. When the receiver FIFO halt trigger level is reached, RTS is deasserted. The sending device (for example, another UART) may send an additional byte after the trigger level is reached (assuming the sending UART has another byte to send) because it may not recognize the deassertion of RTS until it has begun sending the additional byte. RTS is automatically reasserted once the receiver FIFO reaches the resume trigger level programmed via TCR[7:4]. This reassertion allows the sending device to resume transmission.



#### 6.2.2 Auto-CTS

The transmitter circuitry checks  $\overline{\text{CTS}}$  before sending the next data byte. When  $\overline{\text{CTS}}$  is active, the transmitter sends the next byte. To stop the transmitter from sending the following byte,  $\overline{\text{CTS}}$  must be deasserted before the middle of the last stop bit that is currently being sent. The auto- $\overline{\text{CTS}}$  function reduces interrupts to the host system. When flow control is enabled,  $\overline{\text{CTS}}$  level changes do not trigger host interrupts because the device automatically controls its own transmitter. Without auto- $\overline{\text{CTS}}$ , the transmitter sends any data present in the transmit FIFO and a receiver overrun error may result.



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#### 6.3 Software flow control

Software flow control is enabled through the enhanced feature register and the modem control register. Different combinations of software flow control can be enabled by setting different combinations of EFR[3:0]. Table 3 shows software flow control options.

Table 5.	Soltwal	e now cor		
EFR[3]	EFR[2]	EFR[1]	EFR[0]	TX, RX software flow controls
0	0	Х	Х	no transmit flow control
1	0	Х	Х	transmit Xon1, Xoff1
0	1	Х	Х	transmit Xon2, Xoff2
1	1	Х	Х	transmit Xon1, Xon2, Xoff1, Xoff2
Х	Х	0	0	no receive flow control
Х	Х	1	0	receiver compares Xon1, Xoff1
Х	Х	0	1	receiver compares Xon2, Xoff2
1	0	1	1	transmit Xon1, Xoff1
				receiver compares Xon1 or Xon2, Xoff1 or Xoff2
0	1	1	1	transmit Xon2, Xoff2
				receiver compares Xon1 or Xon2, Xoff1 or Xoff2
1	1	1	1	transmit Xon1, Xon2, Xoff1, Xoff2
				receiver compares Xon1 and Xon2, Xoff1 and Xoff2
0	0	1	1	no transmit flow control
				receiver compares Xon1 and Xon2, Xoff1 and Xoff2
,				

Table 3:	Software	flow	control	options	(EFR[3:0])
----------	----------	------	---------	---------	------------

**Remark:** When using software flow control, the Xon/Xoff characters cannot be used for data characters.

There are two other enhanced features relating to software flow control:

- Xon Any function (MCR[5]): Operation will resume after receiving any character after recognizing the Xoff character. It is possible that an Xon1 character is recognized as an Xon Any character, which could cause an Xon2 character to be written to the RX FIFO.
- Special character (EFR[5]): Incoming data is compared to Xoff2. Detection of the special character sets the Xoff interrupt (IIR[4]) but does not halt transmission. The Xoff interrupt is cleared by a read of the IIR. The special character is transferred to the RX FIFO.

#### 6.3.1 RX

When software flow control operation is enabled, the SC16C754B will compare incoming data with Xoff1/Xoff2 programmed characters (in certain cases, Xoff1 and Xoff2 must be received sequentially). When the correct Xoff character is received, transmission is halted after completing transmission of the current character. Xoff detection also sets IIR[4] (if enabled via IER[5]) and causes INT to go HIGH.

To resume transmission, an Xon1/Xon2 character must be received (in certain cases Xon1 and Xon2 must be received sequentially). When the correct Xon characters are received, IIR[4] is cleared, and the Xoff interrupt disappears.

9397 750 14668 Product data sheet

#### 6.3.2 TX

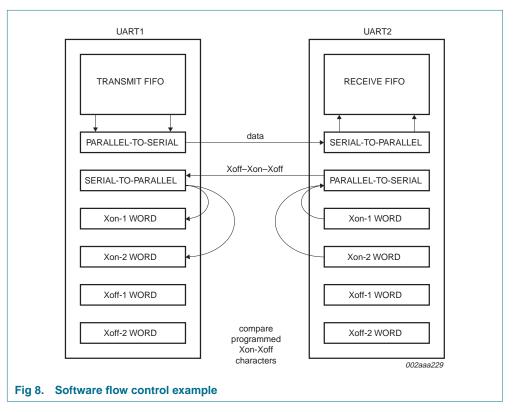
Xoff1/Xoff2 character is transmitted when the RX FIFO has passed the HALT trigger level programmed in TCR[3:0].

Xon1/Xon2 character is transmitted when the RX FIFO reaches the RESUME trigger level programmed in TCR[7:4].

The transmission of Xoff/Xon(s) follows the exact same protocol as transmission of an ordinary byte from the FIFO. This means that even if the word length is set to be 5, 6, or 7 characters, then the 5, 6, or 7 least significant bits of Xoff1/Xoff2 and Xon1/Xon2 will be transmitted. (Note that the transmission of 5, 6, or 7 bits of a character is seldom done, but this functionality is included to maintain compatibility with earlier designs.)

It is assumed that software flow control and hardware flow control will never be enabled simultaneously. Figure 8 shows an example of software flow control.

#### 6.3.3 Software flow control example



#### 6.3.3.1 Assumptions

UART1 is transmitting a large text file to UART2. Both UARTs are using software flow control with single character Xoff (0F) and Xon (0D) tokens. Both have Xoff threshold (TCR[3:0] = F) set to 60, and Xon threshold (TCR[7:4] = 8) set to 32. Both have the interrupt receive threshold (TLR[7:4] = D) set to 52.

9397 750 14668 Product data sheet

UART1 begins transmission and sends 52 characters, at which point UART2 will generate an interrupt to its processor to service the RCV FIFO, but assumes the interrupt latency is fairly long. UART1 will continue sending characters until a total of 60 characters have been sent. At this time, UART2 will transmit a 0F to UART1, informing UART1 to halt transmission. UART1 will likely send the 61<sup>st</sup> character while UART2 is sending the Xoff character. Now UART2 is serviced and the processor reads enough data out of the RX FIFO that the level drops to 32. UART2 will now send a 0D to UART1, informing UART1 to resume transmission.

#### 6.4 Reset

Table 4 summarizes the state of register after reset.

#### Table 4: Register reset functions

-		
Register	Reset control	Reset state
Interrupt enable register	RESET	all bits cleared
Interrupt identification register	RESET	bit 0 is set; all other bits cleared
FIFO control register	RESET	all bits cleared
Line control register	RESET	reset to 0001 1101 (1Dh)
Modem control register	RESET	all bits cleared
Line status register	RESET	bit 5 and bit 6 set; all other bits cleared
Modem status register	RESET	bits 3:0 cleared; bits 7:4 input signals
Enhanced feature register	RESET	all bits cleared
Receiver holding register	RESET	pointer logic cleared
Transmitter holding register	RESET	pointer logic cleared
Transmission control register	RESET	all bits cleared
Trigger level register	RESET	all bits cleared

**Remark:** Registers DLL, DLH, SPR, Xon1, Xon2, Xoff1, Xoff2 are not reset by the top-level reset signal RESET, that is, they hold their initialization values during reset.

Table 5 summarizes the state of registers after reset.

#### Table 5: Signal RESET functions

Signal	Reset control	Reset state
ТХ	RESET	HIGH
RTS	RESET	HIGH
DTR	RESET	HIGH
RXRDY	RESET	HIGH
TXRDY	RESET	LOW



Table 6:

#### 6.5 Interrupts

Interrupt control functions

The SC16C754B has interrupt generation and prioritization (six prioritized levels of interrupts) capability. The interrupt enable register (IER) enables each of the six types of interrupts and the INT signal in response to an interrupt generation. The IER can also disable the interrupt system by clearing bits 7:5 and 3:0. When an interrupt is generated, the IIR indicates that an interrupt is pending and provides the type of interrupt through IIR[5:0]. Table 6 summarizes the interrupt control functions.

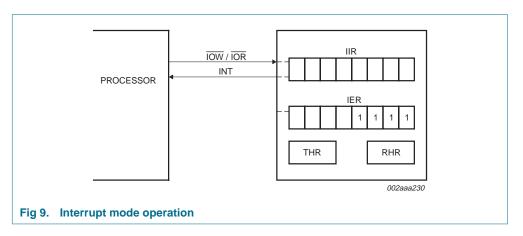
IIR[5:0]	Priority level	Interrupt type	Interrupt source	Interrupt reset method
00 0001	None	none	none	none
00 0110	1	receiver line status	OE, FE, PE, or BI errors occur in characters in the RX FIFO	FE, PE, BI: all erroneous characters are read from the RX FIFO.
				OE: read LSR
00 1100	2	RX time-out	stale data in RX FIFO	read RHR
00 0100	2	RHR interrupt	DRDY (data ready)	read RHR
			(FIFO disable)	
			RX FIFO above trigger level	
			(FIFO enable)	
00 0010	3	THR interrupt	TFE (THR empty)	read IIR or a write to the THR
			(FIFO disable)	
			TX FIFO passes above trigger level	
			(FIFO enable)	
00 0000	4	modem status	MSR[3:0] = 0	read MSR
01 0000	5	Xoff interrupt	receive Xoff character(s)/special character	receive Xon character(s)/Read of IIR
10 0000	6	CTS, RTS	RTS pin or CTS pin change state from active (LOW) to inactive (HIGH)	read IIR

It is important to note that for the framing error, parity error, and break conditions, LSR[7] generates the interrupt. LSR[7] is set when there is an error anywhere in the RX FIFO, and is cleared only when there are no more errors remaining in the FIFO. LSR[4:2] always represent the error status for the received character at the top of the RX FIFO. Reading the RX FIFO updates LSR[4:2] to the appropriate status for the new character at the top of the FIFO. If the RX FIFO is empty, then LSR[4:2] are all zeros.

For the Xoff interrupt, if an Xoff flow character detection caused the interrupt, the interrupt is cleared by an Xon flow character detection. If a special character detection caused the interrupt, the interrupt is cleared by a read of the IIR.

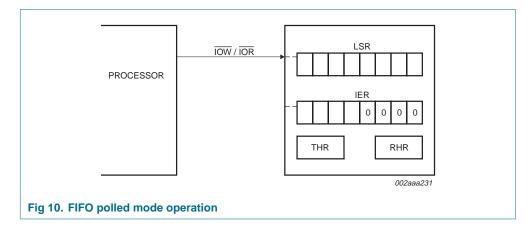
#### 6.5.1 Interrupt mode operation

In interrupt mode (if any bit of IER[3:0] is '1') the processor is informed of the status of the receiver and transmitter by an interrupt signal, INT. Therefore, it is not necessary to continuously poll the line status register (LSR) to see if any interrupt needs to be serviced. Figure 9 shows interrupt mode operation.



#### 6.5.2 Polled mode operation

In polled mode (IER[3:0] = 0000) the status of the receiver and transmitter can be checked by polling the line status register (LSR). This mode is an alternative to the FIFO interrupt mode of operation where the status of the receiver and transmitter is automatically known by means of interrupts sent to the CPU. Figure 10 shows FIFO polled mode operation.



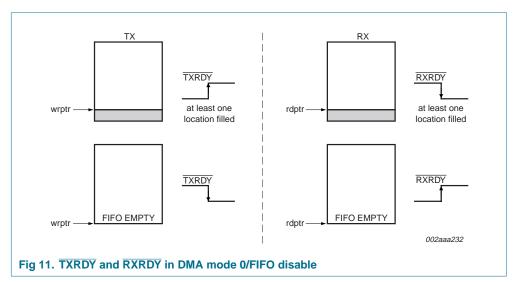
#### 6.6 DMA operation

There are two modes of DMA operation, DMA mode 0 or DMA mode 1, selected by FCR[3].

In DMA mode 0 or FIFO disable (FCR[0] = 0) DMA occurs in single character transfers. In DMA mode 1, multi-character (or block) DMA transfers are managed to relieve the processor for longer periods of time.

#### 6.6.1 Single DMA transfers (DMA mode 0/FIFO disable)

Figure 11 shows TXRDY and RXRDY in DMA mode 0/FIFO disable.



#### 6.6.1.1 Transmitter

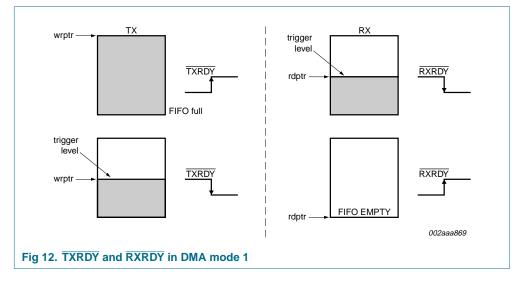
When empty, the  $\overline{\text{TXRDY}}$  signal becomes active.  $\overline{\text{TXRDY}}$  will go inactive after one character has been loaded into it.

### 6.6.1.2 Receiver

RXRDY is active when there is at least one character in the FIFO. It becomes inactive when the receiver is empty.

#### 6.6.2 Block DMA transfers (DMA mode 1)

Figure 12 shows TXRDY and RXRDY in DMA mode 1.



#### 6.6.2.1 Transmitter

TXRDY is active when there is a trigger level number of spaces available. It becomes inactive when the FIFO is full.

#### 6.6.2.2 Receiver

RXRDY becomes active when the trigger level has been reached, or when a time-out interrupt occurs. It will go inactive when the FIFO is empty or an error in the RX FIFO is flagged by LSR[7].

#### 6.7 Sleep mode

Sleep mode is an enhanced feature of the SC16C754B UART. It is enabled when EFR[4], the enhanced functions bit, is set **and** when IER[4] is set. Sleep mode is entered when:

- The serial data input line, RX, is idle (see <u>Section 6.8 "Break and time-out</u> conditions").
- The TX FIFO and TX shift register are empty.
- There are no interrupts pending except THR and time-out interrupts.

Remark: Sleep mode will not be entered if there is data in the RX FIFO.

In Sleep mode, the UART clock and baud rate clock are stopped. Since most registers are clocked using these clocks, the power consumption is greatly reduced. The UART will wake up when any change is detected on the RX line, when there is any change in the state of the modem input pins, or if data is written to the TX FIFO.

**Remark:** Writing to the divisor latches, DLL and DLH, to set the baud clock, must not be done during Sleep mode. Therefore, it is advisable to disable Sleep mode using IER[4] before writing to DLL or DLH.

9397 750 14668 Product data sheet

#### 6.8 Break and time-out conditions

An RX idle condition is detected when the receiver line, RX, has been HIGH for 4 character time. The receiver line is sampled midway through each bit.

When a break condition occurs, the TX line is pulled LOW. A break condition is activated by setting LCR[6].

#### 6.9 Programmable baud rate generator

The SC16C754B UART contains a programmable baud generator that takes any clock input and divides it by a divisor in the range between 1 and  $(2^{16} - 1)$ . An additional divide-by-4 prescaler is also available and can be selected by MCR[7], as shown in Figure 13. The output frequency of the baud rate generator is 16× the baud rate. The formula for the divisor is:

divisor = 
$$\frac{\left(\frac{\text{XTAL1 crystal input frequency}}{\text{prescaler}}\right)}{(\text{desired baud rate } \times 16)}$$

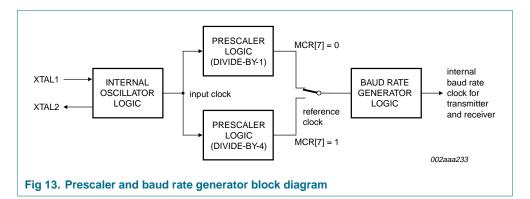
Where:

prescaler = 1, when MCR[7] is set to 0 after reset (divide-by-1 clock selected)

prescaler = 4, when MCR[7] is set to 1 after reset (divide-by-4 clock selected).

Remark: The default value of prescaler after reset is divide-by-1.

Figure 13 shows the internal prescaler and baud rate generator circuitry.



DLL and DLH must be written to in order to program the baud rate. DLL and DLH are the least significant and most significant byte of the baud rate divisor. If DLL and DLH are both zero, the UART is effectively disabled, as no baud clock will be generated.

**Remark:** The programmable baud rate generator is provided to select both the transmit and receive clock rates.

Table 7 and Table 8 show the baud rate and divisor correlation for crystal with frequency 1.8432 MHz and 3.072 MHz, respectively.

Figure 14 shows the crystal clock circuit reference.

9397 750 14668 Product data sheet

#### 5 V, 3.3 V and 2.5 V quad UART, 5 Mbit/s (max.) with 64-byte FIFOs

Desired baud rate	Divisor used to generate 16× clock	Percent error difference between desired and actual
50	2304	
75	1536	
110	1047	0.026
134.5	857	0.058
150	768	
300	384	
600	192	
1200	96	
1800	64	
2000	58	0.69
2400	48	
3600	32	
4800	24	
7200	16	
9600	12	
19200	6	
38400	3	
56000	2	2.86

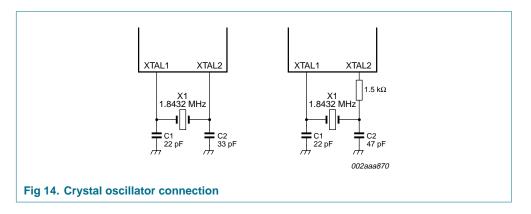
### Table 7: Baud rates using a 1.8432 MHz crystal

#### Table 8:Baud rates using a 3.072 MHz crystal

Desired baud rate	Divisor used to generate 16× clock	Percent error difference between desired and actual
50	3840	
75	2560	
110	1745	0.026
134.5	1428	0.034
150	1280	
300	640	
600	320	
1200	160	
1800	107	0.312
2000	96	
2400	80	
3600	53	0.628
4800	40	
7200	27	1.23
9600	20	
19200	10	
38400	5	

9397 750 14668

Product data sheet



# 7. Register descriptions

Each register is selected using address lines A0, A1, A2, and in some cases, bits from other registers. The programming combinations for register selection are shown in Table 9.

Table 9:		Regis	ter map - read/write properties	
A2	A1	A0	Read mode	Write mode
0	0	0	receive holding register (RHR)	transmit holding register (THR)
0	0	1	interrupt enable register (IER)	interrupt enable register
0	1	0	interrupt identification register (IIR)	FIFO control register (FCR)
0	1	1	line control register (LCR)	line control register
1	0	0	modem control register (MCR) [1]	modem control register [1]
1	0	1	line status register (LSR)	n/a
1	1	0	modem status register (MSR)	n/a
1	1	1	scratchpad register (SPR)	scratchpad register
0	0	0	divisor latch LSB (DLL) [2] [3]	divisor latch LSB [2] [3]
0	0	1	divisor latch MSB (DLH) [2] [3]	divisor latch MSB <sup>[2][3]</sup>
0	1	0	enhanced feature register (EFR) [2] [4]	enhanced feature register [2] [4]
1	0	0	Xon1 word [2] [4]	Xon1 word <sup>[2][4]</sup>
1	0	1	Xon2 word [2] [4]	Xon2 word [2] [4]
1	1	0	Xoff1 word [2] [4]	Xoff1 word [2] [4]
1	1	1	Xoff2 word [2] [4]	Xoff2 word <sup>[2][4]</sup>
1	1	0	transmission control register (TCR) [2] [5]	transmission control register [2] [5]
1	1	1	trigger level register (TLR) [2] [5]	trigger level register [2] [5]
1	1	1	FIFO ready register [2] [6]	

# [1] MCR[7] can only be modified when EFR[4] is set.

[2] Accessed by a combination of address pins and register bits.

[3] Accessible only when LCR[7] is logic 1.

- [4] Accessible only when LCR is set to 1011 1111 (xBF).
- [5] Accessible only when EFR[4] = 1 and MCR[6] = 1, that is, EFR[4] and MCR[6] are read/write enables.
- [6] Accessible only when  $\overline{\text{CSA}} \overline{\text{CSD}} = 0$ , MCR[2] = 1, and loop-back is disabled (MCR[4] = 0).

9397 750 14668

Product data sheet

Rev. 02 — 13 June 2005

#### 5 V, 3.3 V and 2.5 V quad UART, 5 Mbit/s (max.) with 64-byte FIFOs

Table 10 lists and describes the SC16C754B internal registers.

A2	A1	A0	Register	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Read Write
Ger	nera	Reg	gister set [	1]								
)	0	0	RHR	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0	R
)	0	0	THR	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0	W
)	0	1	IER	0/CTS interrupt enable <sup>[2]</sup>	0/RTS interrupt enable <sup>[2]</sup>	0/Xoff [2]	0/X Sleep mode <sup>[2]</sup>	modem status interrupt	receive line status interrupt	THR empty interrupt	Rx data available interrupt	R/W
)	1	0	FCR	RX trigger level (MSB)	RX trigger level (LSB)	0/TX trigger level (MSB) <sup>[2]</sup>	0/TX trigger level (LSB) <sup>[2]</sup>	DMA mode select	TX FIFO reset	RX FIFO reset	FIFO enable	W
)	1	0	IIR	FCR[0]	FCR[0]	0/CTS, RTS	0/Xoff	interrupt priority bit 2	interrupt priority bit 1	interrupt priority bit 0	interrupt status	R
)	1	1	LCR	DLAB	break control bit	set parity	parity type select	parity enable	number of stop bits	word length bit 1	word length bit 0	R/W
	0	0	MCR	1× or 1×/4 clock [2]	TCR and TLR enable <sup>[2]</sup>	0/Xon Any <mark>[2]</mark>	0/enable loop-back	IRQ enable OP	FIFO ready enable	RTS	DTR	R/W
l	0	1	LSR	0/error in RX FIFO	THR and TSR empty	THR empty	break interrupt	framing error	parity error	overrun error	data in receiver	R
	1	0	MSR	CD	RI	DSR	CTS	$\Delta CD$	ΔRI	ΔDSR	∆CTS	R
	1	1	SPR	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0	R/W
	1	0	TCR	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0	R/W
	1	1	TLR	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0	R/W
	1	1	FIFO Rdy	RX FIFO D status	RX FIFO C status	RX FIFO B status	RX FIFO A status	TX FIFO D status	TX FIFO C status	TX FIFO B status	TX FIFO A status	R
ipe	ecial	Reg	ister set [3	1								
	0	0	DLL	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0	R/W
)	0	1	DLH	bit 15	bit 14	bit 13	bit 12	bit 11	bit 10	bit 9	bit 8	R/W
Int	nanc	ed R	legister se		1	1	1		1	1		1
)	1	0	EFR	Auto CTS	Auto RTS	Special character detect	Enable enhanced functions [2]	software flow control bit 3	software flow control bit 2	software flow control bit 1	software flow control bit 0	R/W
	0	0	Xon1	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0	R/W
	0	1	Xon2	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0	R/W
	1	0	Xoff1	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0	R/W
	1	1	Xoff2	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0	R/W

Table 10: SC16C754B internal registers

[1] These registers are accessible only when LCR[7] = 0.

[2] This bit can only be modified if register bit EFR[4] is enabled, that is, if enhanced functions are enabled.

[3] The Special Register set is accessible only when LCR[7] is set to a logic 1.

[4] Enhanced Feature Register; Xon1/Xon2 and Xoff1/Xoff2 are accessible only when LCR is set to 'BFh'.

9397 750 14668

Product data sheet

Rev. 02 — 13 June 2005

**Remark:** Refer to the notes under Table 9 for more register access information.

#### 7.1 Receiver Holding Register (RHR)

The receiver section consists of the Receiver Holding Register (RHR) and the Receiver Shift Register (RSR). The RHR is actually a 64-byte FIFO. The RSR receives serial data from the RX terminal. The data is converted to parallel data and moved to the RHR. The receiver section is controlled by the Line Control Register (LCR). If the FIFO is disabled, location zero of the FIFO is used to store the characters.

Remark: In this case, characters are overwritten if overflow occurs.

If overflow occurs, characters are lost. The RHR also stores the error status bits associated with each character.

### 7.2 Transmit Holding Register (THR)

The transmitter section consists of the Transmit Holding Register (THR) and the Transmit Shift Register (TSR). The THR is actually a 64-byte FIFO. The THR receives data and shifts it into the TSR, where it is converted to serial data and moved out on the TX terminal. If the FIFO is disabled, the FIFO is still used to store the byte. Characters are lost if overflow occurs.

9397 750 14668 Product data sheet

### 7.3 FIFO Control Register (FCR)

This is a write-only register that is used for enabling the FIFOs, clearing the FIFOs, setting transmitter and receiver trigger levels, and selecting the type of DMA signalling. <u>Table 11</u> shows FIFO control register bit settings.

Table 11:	FIFO	Control	Register	bits	description
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Bit	Symbol	Description
7:6	FCR[7] (MSB),	RCVR trigger. Sets the trigger level for the RX FIFO.
	FCR[6] (LSB)	00 - 8 characters
		01 - 16 characters
		10 - 56 characters
		11 - 60 characters
5:4	FCR[5] (MSB),	TX trigger. Sets the trigger level for the TX FIFO.
	FCR[4] (LSB)	00 - 8 spaces
		01 - 16 spaces
		10 - 32 spaces
		11 - 56 spaces
		FCR[5:4] can only be modified and enabled when EFR[4] is set. This is
		because the transmit trigger level is regarded as an enhanced function.
3	FCR[3]	DMA mode select.
		logic 0 = Set DMA mode '0'
		logic 1 = Set DMA mode '1'
2	FCR[2]	Reset TX FIFO.
		logic 0 = no FIFO transmit reset (normal default condition)
		logic 1 = clears the contents of the transmit FIFO and resets the FIFO counter logic (the transmit shift register is not cleared or altered). This bit will return to a logic 0 after clearing the FIFO.
1	FCR[1]	Reset RX FIFO.
		logic 0 = no FIFO receive reset (normal default condition)
		logic 1 = clears the contents of the receive FIFO and resets the FIFO counter logic (the receive shift register is not cleared or altered). This bit will return to a logic 0 after clearing the FIFO.
0	FCR[0]	FIFO enable.
		logic 0 = disable the transmit and receive FIFO (normal default condition)
		logic 1 = enable the transmit and receive FIFO

# 7.4 Line Control Register (LCR)

This register controls the data communication format. The word length, number of stop bits, and parity type are selected by writing the appropriate bits to the LCR. <u>Table 12</u> shows the line control register bit settings.

Table 12: Line Control Register bits description

Bit	Symbol	Description
7	LCR[7]	Divisor latch enable.
		logic 0 = divisor latch disabled (normal default condition)
		logic 1 = divisor latch enabled
6	LCR[6]	Break control bit. When enabled, the Break control bit causes a break condition to be transmitted (the TX output is forced to a logic 0 state). This condition exists until disabled by setting LCR[6] to a logic 0.
		logic 0 = no TX break condition (normal default condition)
		logic 1 = forces the transmitter output (TX) to a logic 0 to alert the communication terminal to a line break condition
5	LCR[5]	Set parity. LCR[5] selects the forced parity format (if LCR[3] = 1).
		logic 0 = parity is not forced (normal default condition)
		LCR[5] = logic 1 <b>and</b> LCR[4] = logic 0: parity bit is forced to a logical 1 for the transmit and receive data
		LCR[5] = logic 1 <b>and</b> LCR[4] = logic 1: parity bit is forced to a logical 0 for the transmit and receive data
4	LCR[4]	Parity type select.
		logic $0 = \text{odd parity is generated (if LCR[3] = 1)}$
		logic 1 = even parity is generated (if LCR[3] = 1)
3	LCR[3]	Parity enable.
		logic 0 = no parity (normal default condition)
		logic 1 = a parity bit is generated during transmission and the receiver checks for received parity
2	LCR[2]	Number of stop bits. Specifies the number of stop bits.
		0 = 1 stop bit (word length = 5, 6, 7, 8)
		1 = 1.5 stop bits (word length = 5)
		1 = 2 stop bits (word length = 6, 7, 8)
1:0	LCR[1:0]	Word length bits 1, 0. These two bits specify the word length to be transmitted or received.
		00 - 5 bits
		01 - 6 bits
		10 - 7 bits
		11 - 8 bits

#### 5 V, 3.3 V and 2.5 V quad UART, 5 Mbit/s (max.) with 64-byte FIFOs

### 7.5 Line Status Register (LSR)

Table 13 shows the line status register bit settings.

Bit	Symbol	Description
7	LSR[7]	FIFO data error.
		logic $0 = no$ error (normal default condition)
		logic 1 = at least one parity error, framing error, or break indication is in the receiver FIFO. This bit is cleared when no more errors are present in the FIFO.
6	LSR[6]	THR and TSR empty. This bit is the Transmit Empty indicator.
		logic 0 = transmitter hold <b>and</b> shift registers are not empty
		logic 1 = transmitter hold <b>and</b> shift registers are empty
5	LSR[5]	THR empty. This bit is the Transmit Holding Register Empty indicator.
		logic 0 = Transmit Hold Register is <b>not</b> empty
		logic 1 = Transmit Hold Register is empty. The processor can now load up to 64 bytes of data into the THR if the TX FIFO is enabled.
4	LSR[4]	Break interrupt.
		logic 0 = no break condition (normal default condition)
		logic 1 = a break condition occurred and associated byte is 00, that is, RX was LOW for one character time frame
3	LSR[3]	Framing error.
		logic 0 = no framing error in data being read from RX FIFO (normal default condition)
		logic 1 = framing error occurred in data being read from RX FIFO, that is, received data did not have a valid stop bit
2	LSR[2]	Parity error.
		logic 0 = no parity error (normal default condition)
		logic 1 = parity error in data being read from RX FIFO
1	LSR[1]	Overrun error.
		logic 0 = no overrun error (normal default condition)
		logic 1 = overrun error has occurred
0	LSR[0]	Data in receiver.
		logic 0 = no data in receive FIFO (normal default condition)
		logic 1 = at least one character in the RX FIFO

When the LSR is read, LSR[4:2] reflect the error bits (BI, FE, PE) of the character at the top of the RX FIFO (next character to be read). The LSR[4:2] registers do not physically exist, as the data read from the RX FIFO is output directly onto the output data bus, DI[4:2], when the LSR is read. Therefore, errors in a character are identified by reading the LSR and then reading the RHR.

LSR[7] is set when there is an error anywhere in the RX FIFO, and is cleared only when there are no more errors remaining in the FIFO.

Reading the LSR does not cause an increment of the RX FIFO read pointer. The RX FIFO read pointer is incremented by reading the RHR.

9397 750 14668 Product data sheet

### 7.6 Modem Control Register (MCR)

The MCR controls the interface with the modem, data set, or peripheral device that is emulating the modem. Table 14 shows Modem Control Register bit settings.

Bit	Symbol	Description
7	MCR[7] [1]	Clock select.
		logic 0 = divide-by-1 clock input
		logic 1 = divide-by-4 clock input
6	MCR[6] [1]	TCR and TLR enable.
		logic 0 = no action
		logic 1 = enable access to the TCR and TLR registers
5	MCR[5] [1]	Xon Any.
		logic 0 = disable Xon Any function
		logic 1 = enable Xon Any function
4	MCR[4]	Enable loop-back.
		logic 0 = normal operating mode
		Logic 1 = enable local loop-back mode (internal). In this mode the MCR[3:0] signals are looped back into MSR[7:4] and the TX output is looped back to the RX input internally.
3	MCR[3]	IRQ enable OP.
		logic 0 = forces INTA-INTB outputs to the 3-state mode and OP output to HIGH state
		logic 1 = forces the INTA-INTB outputs to the active state and OP output to LOW state. In loop-back mode, controls MSR[7].
2	MCR[2]	FIFO Ready enable.
		logic 0 = disable the FIFO Rdy register
		logic 1 = enable the FIFO Rdy register. In loop-back mode, controls MSR[6].
1	MCR[1]	RTS
		logic 0 = force $\overline{RTS}$ output to inactive (HIGH)
		logic 1 = force $\overline{\text{RTS}}$ output to active (LOW). In loop-back mode, controls MSR[4]. If Auto- $\overline{\text{RTS}}$ is enabled, the $\overline{\text{RTS}}$ output is controlled by hardware flow control.
0	MCR[0]	DTR
		logic 0 = force $\overline{\text{DTR}}$ output to inactive (HIGH)
		logic 1 = force $\overline{\text{DTR}}$ output to active (LOW). In loop-back mode, controls MSR[5].

[1] MCR[7:5] can only be modified when EFR[4] is set, that is, EFR[4] is a write enable.

### 7.7 Modem Status Register (MSR)

This 8-bit register provides information about the current state of the control lines from the modem, data set, or peripheral device to the processor. It also indicates when a control input from the modem changes state. <u>Table 15</u> shows Modem Status Register bit settings per channel.

Table 15: Modem Status Register bits description

Bit	Symbol	Description
7	MSR[7][1]	CD (active HIGH, logical 1). This bit is the complement of the $\overline{CD}$ input during normal mode. During internal loop-back mode, it is equivalent to MCR[3].
6	MSR[6][1]	RI (active HIGH, logical 1). This bit is the complement of the $\overline{\text{RI}}$ input during normal mode. During internal loop-back mode, it is equivalent to MCR[2].
5	MSR[5][1]	DSR (active HIGH, logical 1). This bit is the complement of the DSR input during normal mode. During internal loop-back mode, it is equivalent MCR[0].
4	MSR[4][1]	CTS (active HIGH, logical 1). This bit is the complement of the CTS input during normal mode. During internal loop-back mode, it is equivalent to MCR[1].
3	MSR[3]	$\Delta CD$ . Indicates that $\overline{CD}$ input (or MCR[3] in loop-back mode) has changed state. Cleared on a read.
2	MSR[2]	$\Delta RI$ . Indicates that $\overline{RI}$ input (or MCR[2] in loop-back mode) has changed state from LOW to HIGH. Cleared on a read.
1	MSR[1]	$\Delta DSR.$ Indicates that $\overline{DSR}$ input (or MCR[0] in loop-back mode) has changed state. Cleared on a read.
0	MSR[0]	$\Delta \text{CTS}.$ Indicates that CTS input (or MCR[1] in loop-back mode) has changed state. Cleared on a read.

[1] The primary inputs RI, CD, CTS, DSR are all active LOW, but their registered equivalents in the MSR and MCR (in loop-back) registers are active HIGH.

9397 750 14668 Product data sheet

#### 7.8 Interrupt Enable Register (IER)

The Interrupt Enable Register (IER) enables each of the six types of interrupt, receiver error, RHR interrupt, THR interrupt, Xoff received, or CTS/RTS change of state from LOW to HIGH. The INT output signal is activated in response to interrupt generation. <u>Table 16</u> shows Interrupt Enable Register bit settings.

Table 16: Interrupt Enable Register bits description

Bit	Symbol	Description
7	IER[7] [1]	CTS interrupt enable.
		logic 0 = disable the $\overline{CTS}$ interrupt (normal default condition)
		logic 1 = enable the $\overline{CTS}$ interrupt
6	IER[6] [1]	RTS interrupt enable.
		logic 0 = disable the $\overline{RTS}$ interrupt (normal default condition)
		logic 1 = enable the $\overline{\text{RTS}}$ interrupt
5	IER[5] [1]	Xoff interrupt.
		logic 0 = disable the Xoff interrupt (normal default condition)
		logic 1 = enable the Xoff interrupt
4	IER[4] [1]	Sleep mode.
		logic 0 = disable Sleep mode (normal default condition)
		logic 1 = enable Sleep mode. See <u>Section 6.7 "Sleep mode"</u> for details.
3	IER[3]	Modem Status Interrupt.
		logic 0 = disable the modem status register interrupt (normal default condition)
		logic 1 = enable the modem status register interrupt
2	IER[2]	Receive Line Status interrupt.
		logic 0 = disable the receiver line status interrupt (normal default condition)
		logic 1 = enable the receiver line status interrupt
1	IER[1]	Transmit Holding Register interrupt.
		logic 0 = disable the THR interrupt (normal default condition)
		logic 1 = enable the THR interrupt
0	IER[0]	Receive Holding Register interrupt.
		logic 0 = disable the RHR interrupt (normal default condition)
		logic 1 = enable the RHR interrupt

[1] IER[7:4] can only be modified if EFR[4] is set, that is, EFR[4] is a write enable. Re-enabling IER[1] will cause a new interrupt if the THR is below the threshold.

### 7.9 Interrupt Identification Register (IIR)

The IIR is a read-only 8-bit register which provides the source of the interrupt in a prioritized manner. Table 17 shows Interrupt Identification Register bit settings.

Table	Table 17: Interrupt Identification Register bits description				
Bit	Bit Symbol Description				
7-6	IIR[7:6]	Mirror the contents of FCR[0].			
5	IIR[5]	RTS/CTS LOW-to-HIGH change of state.			
4	IIR[4]	1 = Xoff/Special character has been detected.			
3-1	IIR[3:1]	3-bit encoded interrupt. See Table 18.			
0	IIR[0]	Interrupt status. logic 0 = an interrupt is pending logic 1 = no interrupt is pending			

The interrupt priority list is shown in Table 18.

Table 18:	able 18: Interrupt priority list						
Priority level	IIR[5]	IIR[4]	IIR[3]	IIR[2]	lir[1]	IIR[0]	Source of the interrupt
1	0	0	0	1	1	0	Receiver Line Status error
2	0	0	1	1	0	0	Receiver time-out interrupt
2	0	0	0	1	0	0	RHR interrupt
3	0	0	0	0	1	0	THR interrupt
4	0	0	0	0	0	0	Modem interrupt
5	0	1	0	0	0	0	Received Xoff signal/ special character
6	1	0	0	0	0	0	$\overline{\text{CTS}}$ , $\overline{\text{RTS}}$ change of state from active (LOW) to inactive (HIGH)

9397 750 14668

#### 7.10 Enhanced Feature Register (EFR)

This 8-bit register enables or disables the enhanced features of the UART. <u>Table 19</u> shows the Enhanced Feature Register bit settings.

Table 19: Enhanced Feature Register bits description

Bit	Symbol	Description
7	EFR[7]	CTS flow control enable.
		logic 0 = $\overline{\text{CTS}}$ flow control is disabled (normal default condition)
		logic 1 = $\overline{\text{CTS}}$ flow control is enabled. Transmission will stop when a HIGH signal is detected on the $\overline{\text{CTS}}$ pin.
6	EFR[6]	RTS flow control enable.
		logic 0 = $\overline{RTS}$ flow control is disabled (normal default condition)
		logic 1 = $\overline{\text{RTS}}$ flow control is enabled. The $\overline{\text{RTS}}$ pin goes HIGH when the receiver FIFO HALT trigger level TCR[3:0] is reached, and goes LOW when the receiver FIFO RESUME transmission trigger level TCR[7:4] is reached.
5	EFR[5]	Special character detect.
		logic 0 = special character detect disabled (normal default condition)
		logic 1 = special character detect enabled. Received data is compared with Xoff2 data. If a match occurs, the received data is transferred to FIFO and IIR[4] is set to a logical 1 to indicate a special character has been detected.
4	EFR[4]	Enhanced functions enable bit.
		logic 0 = disables enhanced functions and writing to IER[7:4], FCR[5:4], MCR[7:5].
		logic 1 = enables the enhanced function IER[7:4], FCR[5:4], and MCR[7:5] can be modified, that is, this bit is therefore a write enable.
3:0	EFR[3:0]	Combinations of software flow control can be selected by programming these bits. See Table 3 "Software flow control options (EFR[3:0])".

### 7.11 Divisor latches (DLL, DLH)

These are two 8-bit registers which store the 16-bit divisor for generation of the baud clock in the baud rate generator. DLH stores the most significant part of the divisor. DLL stores the least significant part of the divisor.

Note that DLL and DLH can only be written to before Sleep mode is enabled, that is, before IER[4] is set.

9397 750 14668 Product data sheet

#### 7.12 Transmission Control Register (TCR)

This 8-bit register is used to store the RX FIFO threshold levels to stop/start transmission during hardware/software flow control. <u>Table 20</u> shows Transmission Control Register bit settings.

Table 20:	Transmission	<b>Control Register</b>	bits description
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Bit	Symbol	Description
7:4	TCR[7:4]	RX FIFO trigger level to resume transmission (0-60).
3:0	TCR[3:0]	RX FIFO trigger level to halt transmission (0-60).

TCR trigger levels are available from 0 to 60 bytes with a granularity of four.

**Remark:** TCR can only be written to when EFR[4] = 1 and MCR[6] = 1. The programmer must program the TCR such that TCR[3:0] > TCR[7:4]. There is no built-in hardware check to make sure this condition is met. Also, the TCR must be programmed with this condition before Auto-RTS or software flow control is enabled to avoid spurious operation of the device.

### 7.13 Trigger Level Register (TLR)

This 8-bit register is used to store the transmit and received FIFO trigger levels used for DMA and interrupt generation. Trigger levels from 4 to 60 can be programmed with a granularity of 4. Table 21 shows Trigger Level Register bit settings.

	Table 21:	Trigger	Level	Register	bits	description
--	-----------	---------	-------	----------	------	-------------

Bit	Symbol	Description
7:4	TLR[7:4]	RX FIFO trigger levels (4 to 60), number of characters available.
3:0	TLR[3:0]	TX FIFO trigger levels (4 to 60), number of spaces available.

**Remark:** TLR can only be written to when EFR[4] = 1 and MCR[6] = 1. If TLR[3:0] or TLR[7:4] are logical 0, the selectable trigger levels via the FIFO Control Register (FCR) are used for the transmit and receive FIFO trigger levels. Trigger levels from 4 to 60 bytes are available with a granularity of four. The TLR should be programmed for  $N_{4}$ , where N is the desired trigger level.

#### 7.14 FIFO ready register

The FIFO ready register provides real-time status of the transmit and receive FIFOs of both channels.

Table 22:	FIFO	ready	register	bits	descriptio	n
-----------	------	-------	----------	------	------------	---

Bit	Symbol	Description
7:4	FIFO Rdy[7:4]	0 = there are less than a RX trigger level number of characters in the RX FIFO
		1 = the RX FIFO has more than a RX trigger level number of characters available for reading <b>or</b> a time-out condition has occurred
3:0	FIFO Rdy[3:0]	0 = there are less than a TX trigger level number of spaces available in the TX FIFO
		1 = there are at least a TX trigger level number of spaces available in the TX FIFO

9397 750 14668

The FIFO Rdy register is a read-only register that can be accessed when any of the two UARTs is selected  $\overline{CSA} - \overline{CSD} = 0$ , MCR[2] (FIFO Rdy Enable) is a logic 1, and loop-back is disabled. The address is 111.

# 8. Programmer's guide

The base set of registers that is used during high-speed data transfer have a straightforward access method. The extended function registers require special access bits to be decoded along with the address lines. The following guide will help with programming these registers. Note that the descriptions below are for individual register access. Some streamlining through interleaving can be obtained when programming all the registers.

Table 23: Register programming guide

Command	Actions
set baud rate to VALUE1, VALUE2	read LCR (03), save in temp
	set LCR (03) to 80
	set DLL (00) to VALUE1
	set DLM (01) to VALUE2
	set LCR (03) to temp
set Xoff1, Xon1 to VALUE1, VALUE2	read LCR (03), save in temp
	set LCR (03) to BF
	set Xoff1 (06) to VALUE1
	set Xon1 (04) to VALUE2
	set LCR (03) to temp
set Xoff2, Xon2 to VALUE1, VALUE2	read LCR (03), save in temp
	set LCR (03) to BF
	set Xoff-2 (07) to VALUE1
	set Xon-2 (05) to VALUE2
	set LCR (03) to temp
set software flow control mode to VALUE	read LCR (03), save in temp
	set LCR (03) to BF
	set EFR (02) to VALUE
	set LCR (03) to temp
set flow control threshold to VALUE	read LCR (03), save in temp1
	set LCR (03) to BF
	read EFR (02), save in temp2
	set EFR (02) to 10 + temp2
	set LCR (03) to 00
	read MCR (04), save in temp3
	set MCR (04) to 40 + temp3
	set TCR (06) to VALUE
	set MCR (04) to temp3
	set LCR (03) to BF
	set EFR (02) to temp2
	set LCR (03) to temp1

9397 750 14668

Product data sheet

# 5 V, 3.3 V and 2.5 V quad UART, 5 Mbit/s (max.) with 64-byte FIFOs

Table 23:         Register programming guide	econtinued
Command	Actions
set TX FIFO and RX FIFO thresholds	read LCR (03), save in temp1
to VALUE	set LCR (03) to BF
	read EFR (02), save in temp2
	set EFR (02) to 10 + temp2
	set LCR (03) to 00
	read MCR (04), save in temp3
	set MCR (04) to 40 + temp3
	set TLR (07) to VALUE
	set MCR (04) to temp3
	set LCR (03) to BF
	set EFR (02) to temp2
	set LCR (03) to temp1
read FIFO Rdy register	read MCR (04), save in temp1
	set temp2 = temp1 × EF [1]
	set MCR (04) = 40 + temp2
	read FFR (07), save in temp2
	pass temp2 back to host
	set MCR (04) to temp1
set prescaler value to divide-by-1	read LCR (03), save in temp1
	set LCR (03) to BF
	read EFR (02), save in temp2
	set EFR (02) to 10 + temp2
	set LCR (03) to 00
	read MCR (04), save in temp3
	set MCR (04) to temp3 $\times$ 7F <sup>[1]</sup>
	set LCR (03) to BF
	set EFR (02) to temp2
	set LCR (03) to temp1
set prescaler value to divide-by-4	read LCR (03), save in temp1
	ret LCR (03) to BF
	read EFR (02), save in temp2
	set EFR (02) to 10 + temp2
	set LCR (03) to 00
	read MCR (04), save in temp3
	set MCR (04) to temp3 + 80
	set LCR (03) to BF
	set EFR (02) to temp2
	set LCR (03) to temp1

#### Table 23: Register programming guide ...continued

[1]  $\times$  sign here means bit-AND.

9397 750 14668 Product data sheet



5 V, 3.3 V and 2.5 V quad UART, 5 Mbit/s (max.) with 64-byte FIFOs

# 9. Limiting values

Table 24:	Limiting	values
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In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-	7	V
VI	input voltage		-0.3	V <sub>CC</sub> + 0.3	V
Vo	output voltage		-0.3	V <sub>CC</sub> + 0.3	V
T <sub>amb</sub>	ambient temperature	operating in free-air	-40	+85	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

9397 750 14668 Product data sheet

5 V, 3.3 V and 2.5 V quad UART, 5 Mbit/s (max.) with 64-byte FIFOs

# **10. Static characteristics**

#### Table 25: Static characteristics

Tolerance of  $V_{CC} \pm 10$  %, unless otherwise specified.

Symbol	Parameter	Conditions		Vc	<sub>:c</sub> = 2.5	5 V	V <sub>CC</sub> =	3.3 V a	nd 5 V	Unit
				Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage			V <sub>CC</sub> – 10 %	V <sub>CC</sub>	V <sub>CC</sub> + 10 %	V <sub>CC</sub> – 10 %	V <sub>CC</sub>	V <sub>CC</sub> + 10 %	V
VI	input voltage			0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
V <sub>IH</sub>	HIGH-level input voltage		<u>[1]</u>	1.6	-	V <sub>CC</sub>	2.0	-	V <sub>CC</sub>	V
V <sub>IL</sub>	LOW-level input voltage		<u>[1]</u>	-	-	0.65	-	-	0.8	V
Vo	output voltage		[2]	0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
V <sub>OH</sub>	HIGH-level	I <sub>OH</sub> = -8 mA	[3]	-	-	-	2.0	-	-	V
	output voltage	$I_{OH} = -4 \text{ mA}$	<u>[4]</u>	-	-	-	2.0	-	-	V
		I <sub>OH</sub> = -800 μA	[3]	1.85	-	-	-	-	-	V
		$I_{OH} = -400 \ \mu A$	<u>[4]</u>	1.85	-	-	-	-	-	V
V <sub>OL</sub>	LOW-level output	I <sub>OL</sub> = 8 mA	[3]	-	-	-	-	-	0.4	V
	voltage <sup>[5]</sup>	$I_{OL} = 4 \text{ mA}$	[4]	-	-	-	-	-	0.4	V
		$I_{OL} = 2 \text{ mA}$	[3]	-	-	0.4	-	-	-	V
		I <sub>OL</sub> = 1.6 mA	<u>[4]</u>	-	-	0.4	-	-	-	V
Ci	input capacitance			-	-	18	-	-	18	pF
T <sub>amb</sub>	ambient temperature	operating in free air		-40	+25	+85	-40	+25	+85	°C
Тj	junction temperature		<u>[6]</u>	0	25	125	0	25	125	°C
$f_{(i)XTAL1} \\$	crystal input frequency		<u>[7]</u>	-	-	50	-	-	80	MHz
δ	clock duty cycle			-	50	-	-	50	-	%
I <sub>CC</sub>	supply current	f = 5 MHz	[8]	-	-	4.5	-	-	6	mA
I <sub>CCsleep</sub>	sleep current		[9]	-	200	-	-	200	-	μΑ

[1] Meets TTL levels,  $V_{IO(min)} = 2 V$  and  $V_{IH(max)} = 0.8 V$  on non-hysteresis inputs.

[2] Applies for external output buffers.

[3] These parameters apply for D7 to D0.

[4] These parameters apply for DTRA, DTRB, INIA, INTB, RTSA, RTSB, RXRDYA, RXRDYB, TXRDYA, TXRDYB, TXA, TXB.

[5] Except XTAL2, V<sub>OL</sub> = 1 V typical.

[6] These junction temperatures reflect simulated conditions. Absolute maximum junction temperature is 150 °C. The customer is responsible for verifying junction temperature.

[7] Applies to external clock; crystal oscillator max. 24 MHz.

[8] Measurement condition, normal operation other than Sleep mode: V<sub>CC</sub> = 3.3 V; T<sub>amb</sub> = 25 °C. Full duplex serial activity on all two serial (UART) channels at the clock frequency specified in the recommended operating conditions with divisor of 1.

[9] When using crystal oscillator. The use of an external clock will increase the sleep current.

9397 750 14668

**Product data sheet** 

#### 5 V, 3.3 V and 2.5 V quad UART, 5 Mbit/s (max.) with 64-byte FIFOs

# **11. Dynamic characteristics**

#### Table 26: Dynamic characteristics

 $T_{amb} = -40 \degree C$  to +85 °C; tolerance of  $V_{CC} \pm 10$  %, unless otherwise specified.

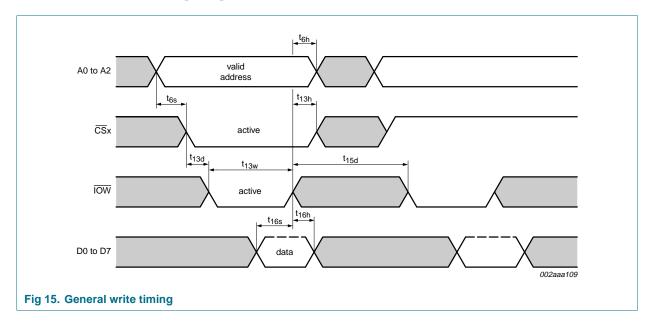
Symbol	Parameter	Conditions	$V_{CC} = 2.5 V$		$V_{CC} = 3.3 V$		$V_{CC} = 5.0 V$		Unit
			Min	Max	Min	Max	Min	Max	
t <sub>1w</sub> , t <sub>2w</sub>	clock pulse duration		10	-	6	-	6	-	ns
f <sub>XTAL</sub>	oscillator/clock frequency	[1][2]	-	48	-	80		80	MHz
t <sub>6s</sub>	address setup time		0	-	0	-	0	-	ns
t <sub>6h</sub>	address hold time		0	-	0	-	0	-	ns
t <sub>7d</sub>	IOR delay from chip select		10	-	10	-	10	-	ns
t <sub>7w</sub>	IOR strobe width	25 pF load	90	-	26	-	23	-	ns
t <sub>7h</sub>	chip select hold time from $\overline{\text{IOR}}$		0	-	0	-	0	-	ns
t <sub>9d</sub>	read cycle delay	25 pF load	20	-	20	-	20	-	ns
t <sub>12d</sub>	delay from IOR to data	25 pF load	-	90	-	26	-	23	ns
t <sub>12h</sub>	data disable time	25 pF load	-	15	-	15	-	15	ns
t <sub>13d</sub>	IOW delay from chip select		10	-	10	-	10	-	ns
t <sub>13w</sub>	IOW strobe width		20	-	20	-	15	-	ns
t <sub>13h</sub>	chip select hold time from $\overline{\text{IOW}}$		0	-	0	-	0	-	ns
t <sub>15d</sub>	write cycle delay		25	-	25	-	20	-	ns
t <sub>16s</sub>	data setup time		20	-	15	-	15	-	ns
t <sub>16h</sub>	data hold time		15	-	5	-	5	-	ns
t <sub>17d</sub>	delay from IOW to output	25 pF load	-	100	-	33	-	29	ns
t <sub>18d</sub>	delay to set interrupt from Modem input	25 pF load	-	100	-	24	-	23	ns
t <sub>19d</sub>	delay to reset interrupt from IOR	25 pF load	-	100	-	24	-	23	ns
t <sub>20d</sub>	delay from stop to set interrupt		-	1T <sub>RCLK</sub> [3]	-	1T <sub>RCLK</sub> [3]	-	1T <sub>RCLK</sub> [3]	ns
t <sub>21d</sub>	delay from IOR to reset interrupt	25 pF load	-	100	-	29	-	28	ns
t <sub>22d</sub>	delay from start to set interrupt		-	100	-	45	-	40	ns
t <sub>23d</sub>	delay from IOW to transmit start		8T <sub>RCLK</sub> [ <u>3]</u>	24T <sub>RCLK</sub> [3]	8T <sub>RCLK</sub>	24T <sub>RCLK</sub>	8T <sub>RCLK</sub>	24T <sub>RCLK</sub> [3]	ns
t <sub>24d</sub>	delay from IOW to reset interrupt		-	100	-	45	-	40	ns
t <sub>25d</sub>	delay from stop to set $\overline{RXRDY}$		-	1T <sub>RCLK</sub> [3]	-	1T <sub>RCLK</sub> [3]	-	1T <sub>RCLK</sub> [3]	ns
t <sub>26d</sub>	delay from IOR to reset RXRDY		-	100	-	45	-	40	ns
t <sub>27d</sub>	delay from $\overline{\text{IOW}}$ to set $\overline{\text{TXRDY}}$		-	100	-	45	-	40	ns
t <sub>28d</sub>	delay from start to reset TXRDY		-	8T <sub>RCLK</sub>	-	8T <sub>RCLK</sub>	-	8T <sub>RCLK</sub> [3]	ns
t <sub>RESET</sub>	RESET pulse width		200	-	200	-	200	-	ns
			1	(2 <sup>16</sup> – 1)		(2 <sup>16</sup> – 1)		(2 <sup>16</sup> – 1)	

[1] Applies to external clock, crystal oscillator max 24 MHz.

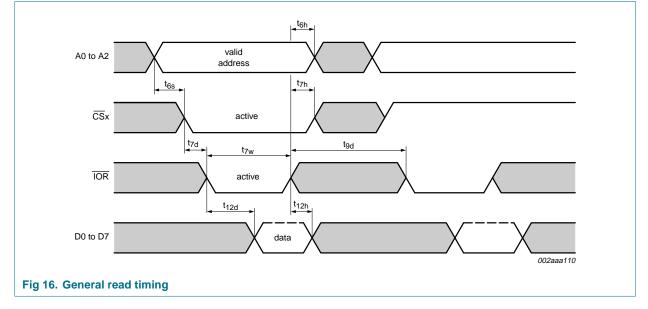
9397 750 14668

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- [2] Maximum frequency =  $\frac{1}{t_{3w}}$
- [3] RCLK is an internal signal derived from divisor latch LSB (DLL) and divisor latch MSB (DLM) divisor latches.



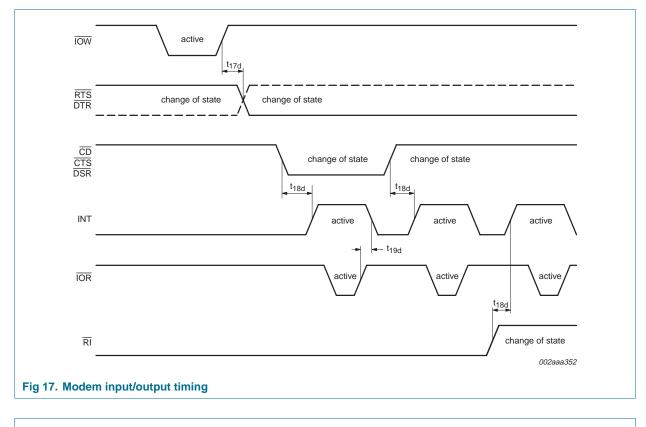
### **11.1 Timing diagrams**

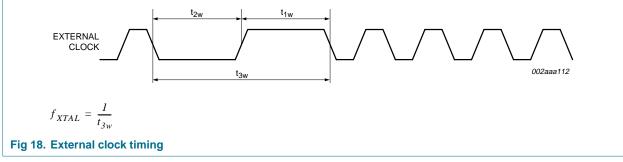


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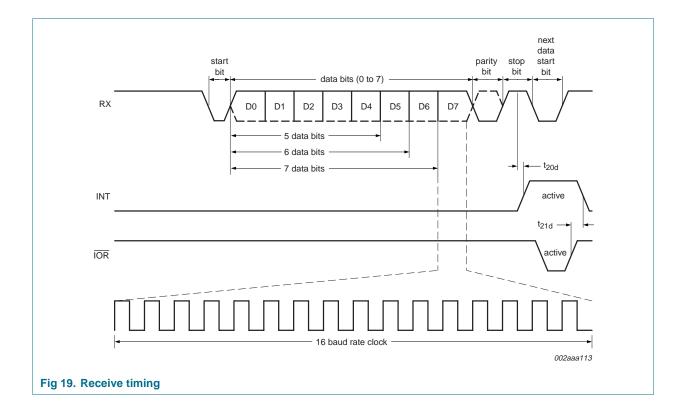


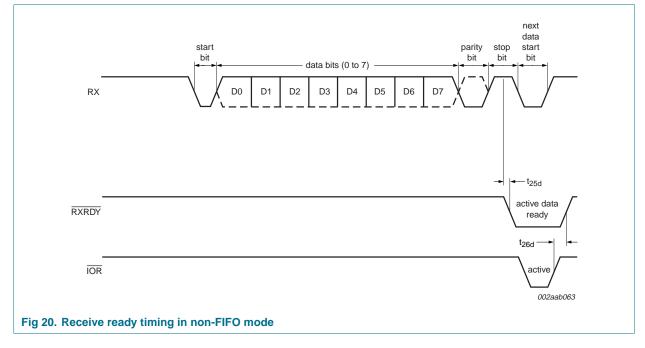


9397 750 14668 Product data sheet

# SC16C754B

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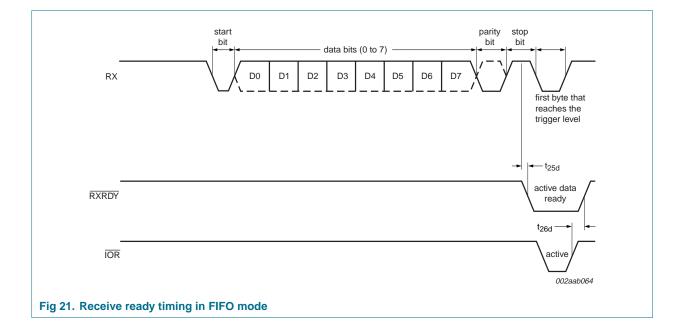


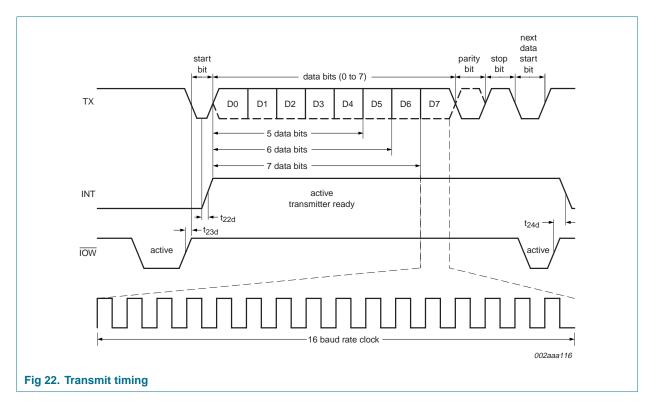


9397 750 14668

SC16C754B

5 V, 3.3 V and 2.5 V quad UART, 5 Mbit/s (max.) with 64-byte FIFOs

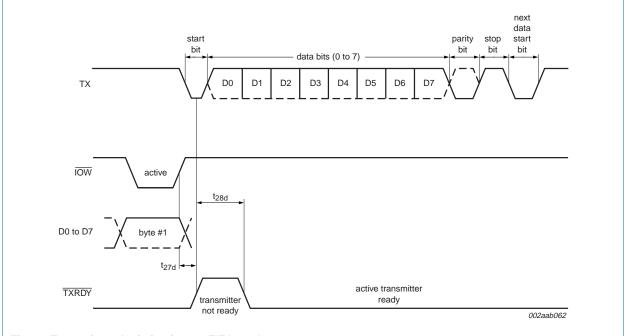




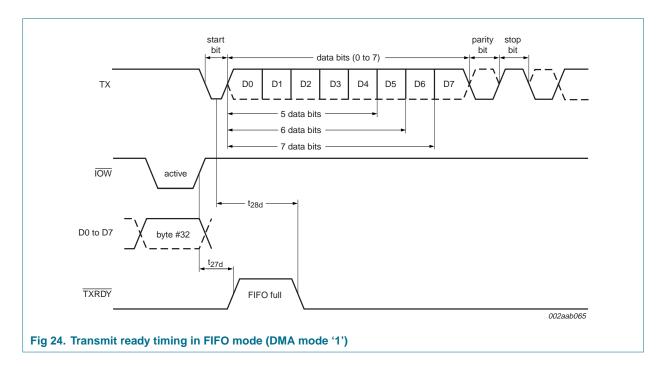
9397 750 14668

# SC16C754B

5 V, 3.3 V and 2.5 V quad UART, 5 Mbit/s (max.) with 64-byte FIFOs



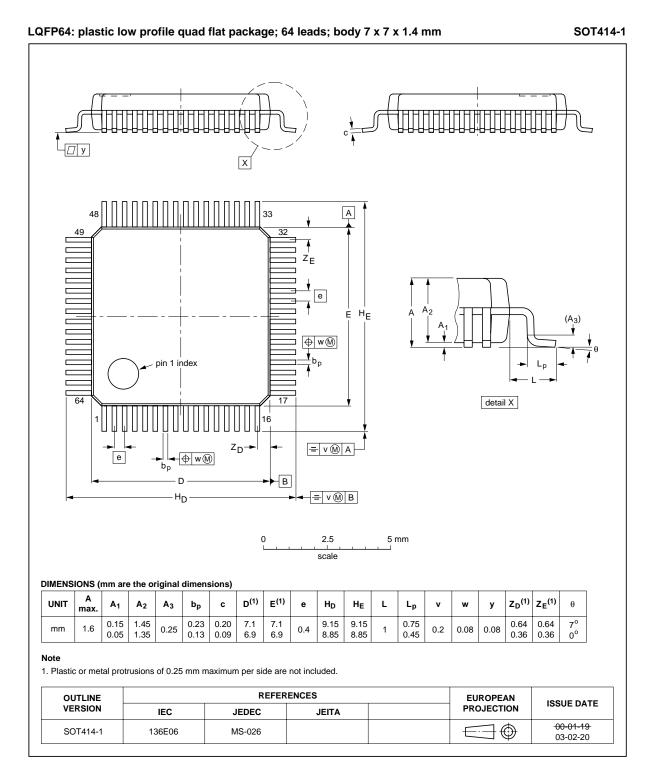




9397 750 14668

5 V, 3.3 V and 2.5 V quad UART, 5 Mbit/s (max.) with 64-byte FIFOs

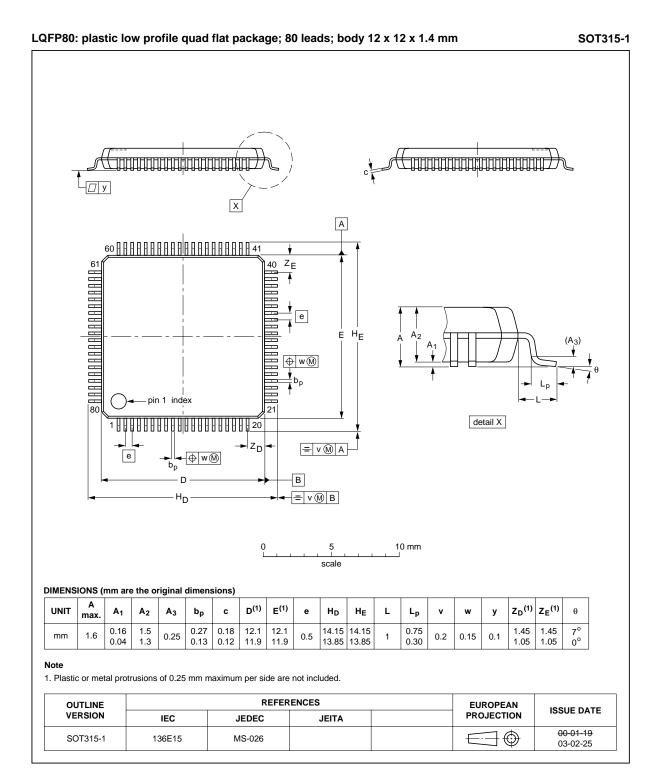
# 12. Package outline



#### Fig 25. Package outline SOT414-1 (LQFP64)

9397 750 14668

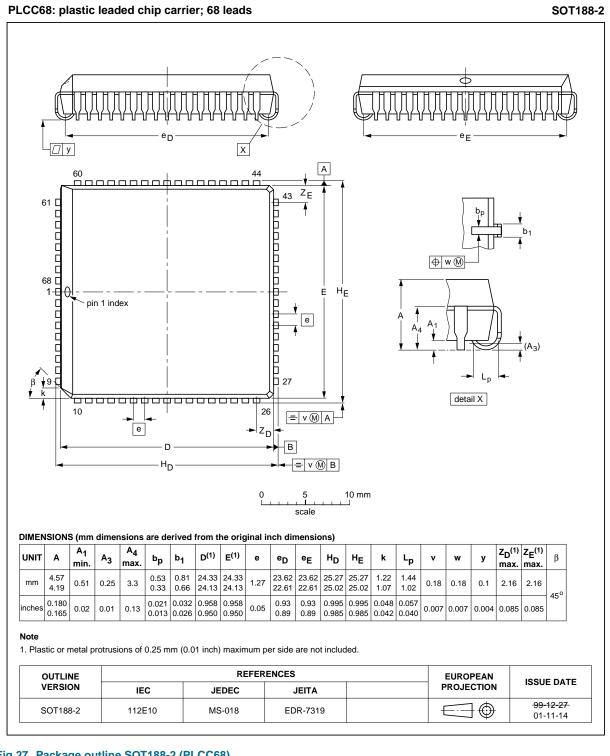
5 V, 3.3 V and 2.5 V quad UART, 5 Mbit/s (max.) with 64-byte FIFOs



#### Fig 26. Package outline SOT315-1 (LQFP80)

9397 750 14668

5 V, 3.3 V and 2.5 V quad UART, 5 Mbit/s (max.) with 64-byte FIFOs



#### Fig 27. Package outline SOT188-2 (PLCC68)

9397 750 14668

5 V, 3.3 V and 2.5 V quad UART, 5 Mbit/s (max.) with 64-byte FIFOs

## 13. Soldering

#### **13.1** Introduction to soldering surface mount packages

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our *Data Handbook IC26; Integrated Circuit Packages* (document order number 9398 652 90011).

There is no soldering method that is ideal for all surface mount IC packages. Wave soldering can still be used for certain surface mount ICs, but it is not suitable for fine pitch SMDs. In these situations reflow soldering is recommended.

#### 13.2 Reflow soldering

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement. Driven by legislation and environmental forces the worldwide use of lead-free solder pastes is increasing.

Several methods exist for reflowing; for example, convection or convection/infrared heating in a conveyor type oven. Throughput times (preheating, soldering and cooling) vary between 100 seconds and 200 seconds depending on heating method.

Typical reflow peak temperatures range from 215 °C to 270 °C depending on solder paste material. The top-surface temperature of the packages should preferably be kept:

- below 225 °C (SnPb process) or below 245 °C (Pb-free process)
  - for all BGA, HTSSON..T and SSOP..T packages
  - for packages with a thickness  $\geq$  2.5 mm
  - for packages with a thickness < 2.5 mm and a volume ≥ 350 mm<sup>3</sup> so called thick/large packages.
- below 240 °C (SnPb process) or below 260 °C (Pb-free process) for packages with a thickness < 2.5 mm and a volume < 350 mm<sup>3</sup> so called small/thin packages.

Moisture sensitivity precautions, as indicated on packing, must be respected at all times.

#### 13.3 Wave soldering

Conventional single wave soldering is not recommended for surface mount devices (SMDs) or printed-circuit boards with a high component density, as solder bridging and non-wetting can present major problems.

To overcome these problems the double-wave soldering method was specifically developed.

If wave soldering is used the following conditions must be observed for optimal results:

- Use a double-wave soldering method comprising a turbulent wave with high upward pressure followed by a smooth laminar wave.
- For packages with leads on two sides and a pitch (e):
  - larger than or equal to 1.27 mm, the footprint longitudinal axis is preferred to be parallel to the transport direction of the printed-circuit board;

9397 750 14668 Product data sheet

46 of 50

#### 5 V, 3.3 V and 2.5 V quad UART, 5 Mbit/s (max.) with 64-byte FIFOs

 smaller than 1.27 mm, the footprint longitudinal axis must be parallel to the transport direction of the printed-circuit board.

The footprint must incorporate solder thieves at the downstream end.

• For packages with leads on four sides, the footprint must be placed at a 45° angle to the transport direction of the printed-circuit board. The footprint must incorporate solder thieves downstream and at the side corners.

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Typical dwell time of the leads in the wave ranges from 3 seconds to 4 seconds at 250 °C or 265 °C, depending on solder material applied, SnPb or Pb-free respectively.

A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

#### 13.4 Manual soldering

Fix the component by first soldering two diagonally-opposite end leads. Use a low voltage (24 V or less) soldering iron applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300  $^{\circ}$ C.

When using a dedicated tool, all other leads can be soldered in one operation within 2 seconds to 5 seconds between 270  $^{\circ}$ C and 320  $^{\circ}$ C.

#### 13.5 Package related soldering information

Table 27:	Suitability of surface mount IC packages for wave and reflow soldering methods
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Package [1]	Soldering method		
	Wave	Reflow <sup>[2]</sup>	
BGA, HTSSONT <sup>[3]</sup> , LBGA, LFBGA, SQFP, SSOPT <sup>[3]</sup> , TFBGA, VFBGA, XSON	not suitable	suitable	
DHVQFN, HBCC, HBGA, HLQFP, HSO, HSOP, HSQFP, HSSON, HTQFP, HTSSOP, HVQFN, HVSON, SMS	not suitable 4	suitable	
PLCC <sup>[5]</sup> , SO, SOJ	suitable	suitable	
LQFP, QFP, TQFP	not recommended [5] [6]	suitable	
SSOP, TSSOP, VSO, VSSOP	not recommended [7]	suitable	
CWQCCNL <sup>[8]</sup> , PMFP <sup>[9]</sup> , WQCCNL <sup>[8]</sup>	not suitable	not suitable	

 For more detailed information on the BGA packages refer to the (LF)BGA Application Note (AN01026); order a copy from your Philips Semiconductors sales office.

- [2] All surface mount (SMD) packages are moisture sensitive. Depending upon the moisture content, the maximum temperature (with respect to time) and body size of the package, there is a risk that internal or external package cracks may occur due to vaporization of the moisture in them (the so called popcorn effect). For details, refer to the Drypack information in the Data Handbook IC26; Integrated Circuit Packages; Section: Packing Methods.
- [3] These transparent plastic packages are extremely sensitive to reflow soldering conditions and must on no account be processed through more than one soldering cycle or subjected to infrared reflow soldering with peak temperature exceeding 217 °C ± 10 °C measured in the atmosphere of the reflow oven. The package body peak temperature must be kept as low as possible.

9397 750 14668 Product data sheet

5 V, 3.3 V and 2.5 V quad UART, 5 Mbit/s (max.) with 64-byte FIFOs

- [4] These packages are not suitable for wave soldering. On versions with the heatsink on the bottom side, the solder cannot penetrate between the printed-circuit board and the heatsink. On versions with the heatsink on the top side, the solder might be deposited on the heatsink surface.
- [5] If wave soldering is considered, then the package must be placed at a 45° angle to the solder wave direction. The package footprint must incorporate solder thieves downstream and at the side corners.
- [6] Wave soldering is suitable for LQFP, QFP and TQFP packages with a pitch (e) larger than 0.8 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.65 mm.
- [7] Wave soldering is suitable for SSOP, TSSOP, VSO and VSSOP packages with a pitch (e) equal to or larger than 0.65 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.5 mm.
- [8] Image sensor packages in principle should not be soldered. They are mounted in sockets or delivered pre-mounted on flex foil. However, the image sensor package can be mounted by the client on a flex foil by using a hot bar soldering process. The appropriate soldering profile can be provided on request.
- [9] Hot bar soldering or manual soldering is suitable for PMFP packages.

Document ID	Release date	Data sheet status	Change notice	Doc. number	Supersedes			
SC16C754B_2	20050613	Product data sheet	-	9397 750 14668	SC16C754B_1			
Modifications:	<ul> <li>Section 1 "General description", 3rd paragraph: added 'LQFP64'</li> </ul>							
	<ul> <li>Section 2 "Features", 4th bullet: changed 'baud rate' to 'data rate' (2 places)</li> </ul>							
	• Table 1 "C	Ordering information": ad	ded LQFP64 packag	ge offering				
	<ul> <li>Figure 2 "</li> </ul>	Pin configuration for LQ	P64" added					
	<u>Table 2 "Pin description"</u> :							
		<ul> <li>added column for LQFP64 pinning</li> </ul>						
		<ul> <li>descriptions for CLKSEL, INTSEL, RXRDY, TXRDY modified to indicate the package-type to which they apply</li> </ul>						
	Table 10 " note 2	SC16C754B internal rec	jisters": shading rem	oved, replaced with	reference to Table			
	• <u>Table 24</u> "	<ul> <li>Table 24 "Limiting values": table note removed (statement shown in Section 17 "Disclaimers")</li> </ul>						
	• <u>Table 25 "</u>	<u>Table 25 "Static characteristics":</u>						
	– description following title changed from 'V <sub>CC</sub> = 2.5 V, 3.3 V $\pm$ 10 % or 5 V $\pm$ 10 %' to 'Tolerance of V <sub>CC</sub> $\pm$ 10 %; unless otherwise specified.'							
	– Added	<ul> <li>Added 'V<sub>CC</sub> =' to value limits column headings</li> </ul>						
	– <u>Table r</u>	note 5: changed 'x <sub>2</sub> ' to 'X	TAL2'					
	• <u>Table 26</u> "	Dynamic characteristics	•. _•					
	– symbo	I ' $t_{3w}$ ' changed to ' $f_{XTAL}$ ';	added reference to	(new) Table note 2				
	<ul> <li>under values for t<sub>20d</sub>, t<sub>23d</sub>, t<sub>25d</sub>, t<sub>28d</sub>: changed 'RCLK cycles' to 'T<sub>RCLK</sub>'; added reference to <u>Table note 3</u>; added unit 'ns'</li> </ul>							
	<ul> <li>symbol N: removed 'RCLK cycle(s)' from values (N is a number)</li> </ul>							
	<ul> <li>added (new) <u>Table note 2</u></li> </ul>							
	• Figure 25	"Package outline SOT4"	4-1 (LQFP64)" add	ed				
	Section 18	<u>3 "Trademarks"</u> added						
SC16C754B_1	20050127	Product data sheet	-	9397 750 13114	-			

# 14. Revision history

9397 750 14668 Product data sheet

## 15. Data sheet status

Level	Data sheet status [1]	Product status [2] [3]	Definition
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# SC16C754B

5 V, 3.3 V and 2.5 V quad UART, 5 Mbit/s (max.) with 64-byte FIFOs

### 20. Contents

1	General description 1
2	Features 1
3	Ordering information 2
4	Block diagram 3
5	Pinning information 4
5.1	Pinning
5.2	Pin description 6
6	Functional description 9
6.1	Trigger levels
6.2	Hardware flow control
6.2.1	Auto-RTS 11
6.2.2	Auto-CTS
6.3	Software flow control 12
6.3.1	RX 12
6.3.2	TX 13
6.3.3	Software flow control example 13
6.3.3.1	Assumptions
6.4	Reset 14
6.5	Interrupts 15
6.5.1	Interrupt mode operation
6.5.2	Polled mode operation 16
6.6	DMA operation 17
6.6.1	Single DMA transfers (DMA mode 0/FIFO
	disable)
6.6.1.1	Transmitter 17
6.6.1.2	Receiver
6.6.2	Block DMA transfers (DMA mode 1) 18
6.6.2.1	Transmitter 18
6.6.2.2	Receiver
6.7	Sleep mode
6.8	Break and time-out conditions
6.9	Programmable baud rate generator 19
7	Register descriptions 21
7.1	Receiver Holding Register (RHR) 23
7.2	Transmit Holding Register (THR) 23
7.3	FIFO Control Register (FCR) 24
7.4	Line Control Register (LCR) 25
7.5	Line Status Register (LSR)
7.6	Modem Control Register (MCR)
7.7	Modem Status Register (MSR)
7.8	Interrupt Enable Register (IER)
7.9	Interrupt Identification Register (IIR)
7.10	Enhanced Feature Register (EFR)
7.11	Divisor latches (DLL, DLH)
7.12	Transmission Control Register (TCR) 32
7.13	Trigger Level Register (TLR)
7.14	FIFO ready register

8	Programmer's guide	33
9	Limiting values	35
10	Static characteristics	36
11	Dynamic characteristics	37
11.1	Timing diagrams	38
12	Package outline	43
13	Soldering	46
13.1	Introduction to soldering surface mount	
	packages	46
13.2	Reflow soldering.	46
13.3	Wave soldering.	46
13.4	Manual soldering	47
13.5	Package related soldering information	47
14	Revision history	48
15	Data sheet status	49
16	Definitions	49
17	Disclaimers	49
18	Trademarks	49
19	Contact information	49

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